### **Description**

The dual monolithic silicon Zener diodes are designed for applications requiring transient over voltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. Their dual junction common anode design protects two separate lines using only one package. These devices ideal for situations where board space is at a premium.

#### **Features**

- SOT-23 package allows either two separate unidirectional configurations or a single bidirectional configuration.
- Working peak reverse voltage 15V
- Standard Zener breakdown voltage 5.1V to 33V
- Peak power 40 Watts
- ESD Rating:
   Class 3B (>16kV) per the Human Body Model
   Class C (>400V) per Machine Model
- ESD Rating of IEC61000-4-2 level 4
- Low leakage < 5.0µA</p>

### **Machanical Data**

- SOT-23 package
- Flammability Rating: UL 94V-0
- Packaging: Tape and Reel
- High temperature soldering guaranted:260 °C / 10 s
- Reel size: 7 inch

## **Ordering Information**

Device: SZMMBZ15VALT1G

Package: SOT-23

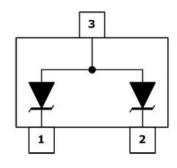
Material: RoHS compliantPacking: Tape & Reel

Quantity per reel: 3,000pcs

## **Applications**

- Computers
- Printers
- Business Machines
- Communication systems
- Medical equipment

### **Pin Configuration**



### **Package Outline**





# **Absolute Maximum Rating**

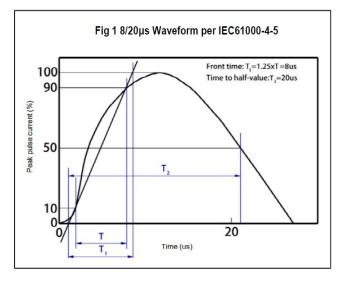
Symbol	Parameter	Value	Units
Ррк	Peak Power Dissipation	40	W
Торт	Operating Temperature	-55~150	°C
Тѕтс	Storage Temperature	-55~150	°C
Po	Total Power Dissipation	200	mW

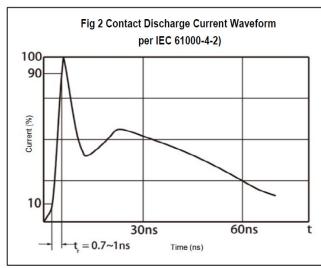
# Electrial Characteristics (Tamb=25°C)

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
V <sub>RWM</sub>	Reverse Working Voltage				12	V
V <sub>BR</sub>	Reverse Breakdown Voltage	I⊤ = 1mA	14.25	15.00	15.75	V
lR	Reverse Leakage Current	$V_{\text{RWM}} = 12V$			50	nA
Vc	Clamping Voltage	$I_{PP} = 1.9A, t_p = 8/20 \mu s$			21	V

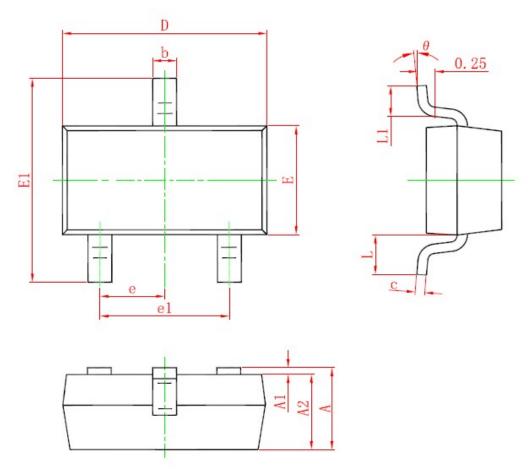
 $V_F$ =0.9V Max @  $I_F$ =10mA

### **Electrial Characteristics Curve**





## **Outline And Dimensions**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
Е	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

# SZMMBZ15VALT1G

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